Electronic Pate	ent App	lication Fee	Transmit	tal			
Application Number:	109	10540866					
Filing Date:	27-	27-Jun-2005					
Title of Invention:	po	Expandable resin beads of styrene-modified straight-chain and low-density polyethylenne, process the production thereof, pre-expanded beads, and foams					
First Named Inventor/Applicant Name:	Hic	Hideyasu Matsumura					
Filer:	He	Heribert Muensterer/Liping Qi					
Attorney Docket Number:	P21	P28094					
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Fi	ling Fee	s					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:			1		1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Request for oral hearing		1403	1	1080	1080		
Post-Allowance-and-Post-Issuance:			'				
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			1080